Next Vision Display
Brighten The Future

NEXT VISION DISPLAY

SPECIFICATION

CUSTOMER : NH1601BN001ML

MODULE NO.:

Version	
Engineer	
Date	

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Customer:
Approved by

NEXT VISION DISPLAY CO., LTD.

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1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	16characters × 1 lines
LCD Type	STN Negative, Blue Transmissive
Driver Condition	LCD Module : 1/16Duty , 1/5Bias
Viewing Direction	6 O'clock
Backlight Type	LED
Interface	8-bit MPU interface
Driver IC	SPLC780D

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	122(L) x 33(W) x Max 13.0(T)	mm
Viewing Area	99(L) x13(W)	mm
Dot size	0.92(W) × 1.1(H)	mm
Dot pitch	0.98(W) × 1.16(H)	mm
Character size	4.84(W) × 8.06(H)	mm

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1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDD	-	-0.3	5.5	V
LCD Driver Supply Voltage	VLCD	-	VDD-12	VDD-0.3	V
Input Voltage	V_{IN}	-	-0.3	VDD + 0.3	V
Operating Temperature	T_{OP}	-	-20	70	°C
Storage Temperature	T_{ST}	-	-30	80	°C
Storage Humidity	H_D	Ta < 40 °C	20	90	%RH

1.4 DC Electrical Characteristics

VDD = 5.0V ± 0.2V, GND = 0V, Ta = 25°C

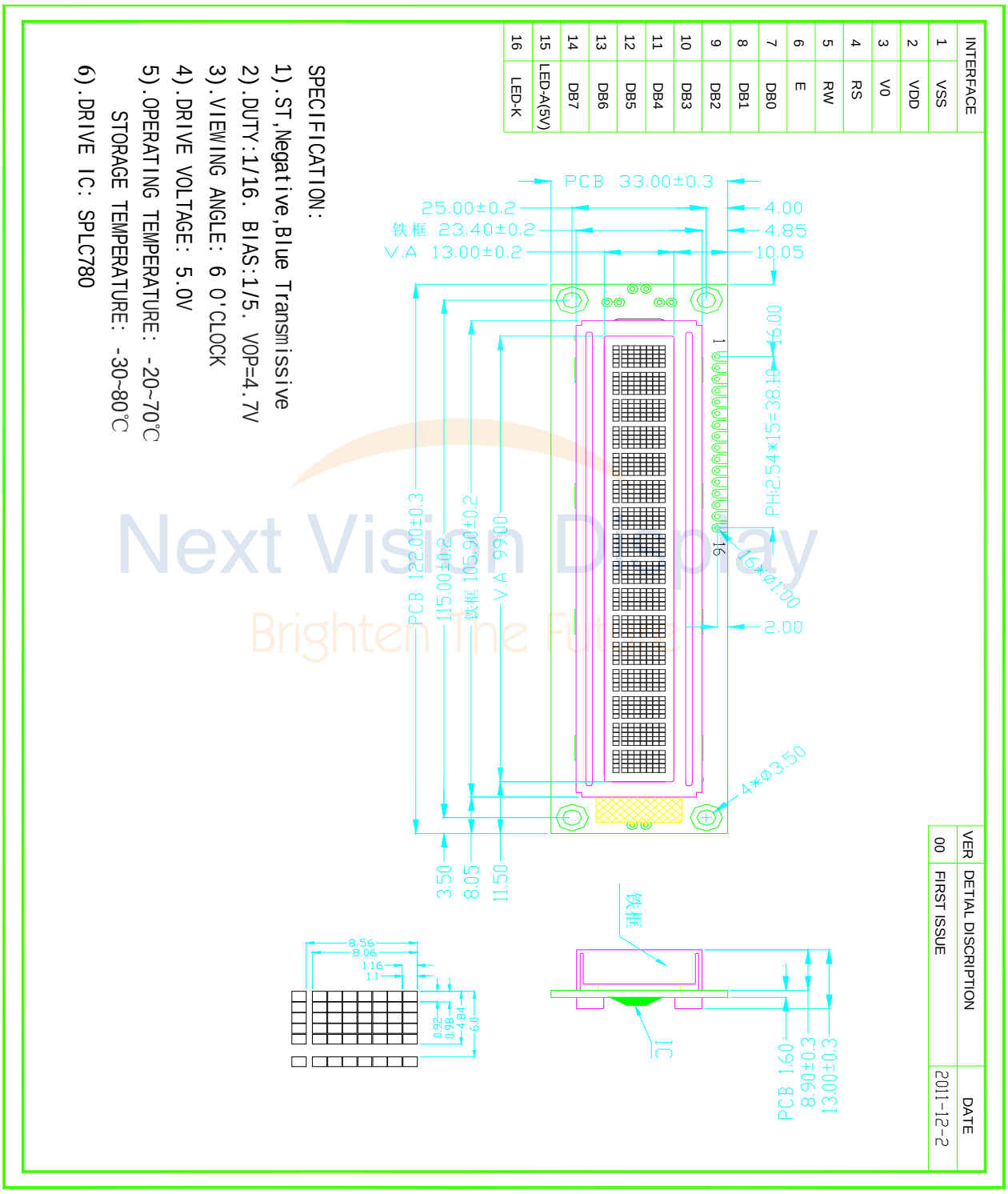
Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Logic Supply Voltage	VDD	-	3.0	5.0	5.5	V
Input High Voltage	V_{IH}	-	0.8VDD	-	VDD	V
Input Low Voltage	V_{IL}	-	GND	-	0.3VDD	V
Output High Voltage	V_{OH}	-	0.7VDD	-	VDD	V
Output Low Voltage	V_{OL}	-	GND	-	0.2VDD	V

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2. MODULE STRUCTURE

2.1 Counter Drawing

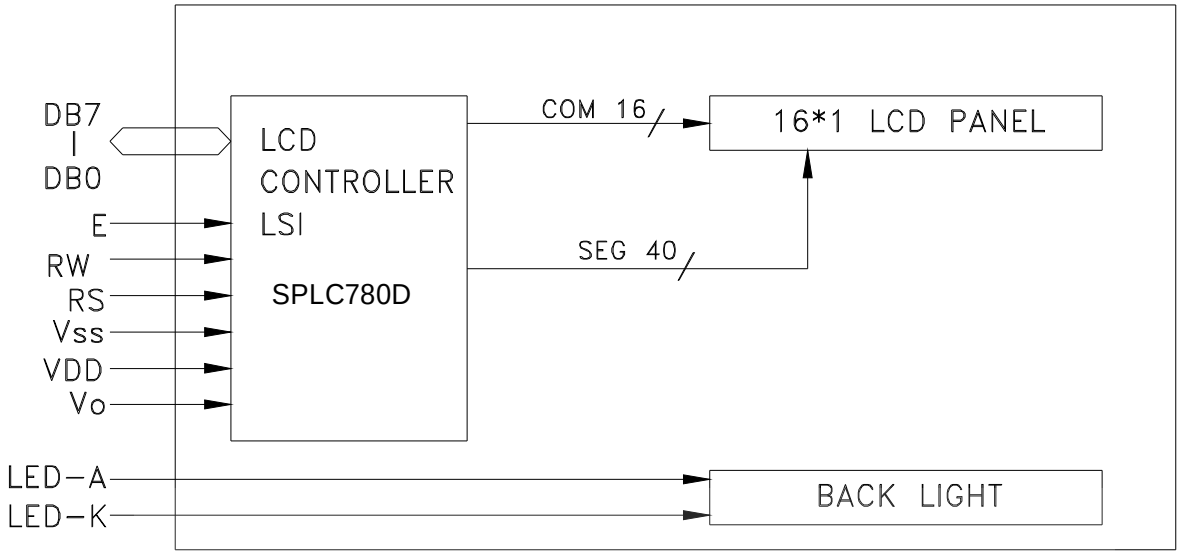
2.1.1 LCM Mechanical Diagram



2.2 Interface Pin Description

No.	Symbol	Function
1	VSS	Ground (0V)
2	VDD	Supply Voltage for Logic (+5.0V)
3	VO	Contrast Adjustment
4	RS	Data/Instruction Select
5	R/W	Read/Write Select
6	E	Enable Signal
7	DB0	Data Bus
8	DB1	Data Bus
9	DB2	Data Bus
10	DB3	Data Bus
11	DB4	Data Bus
12	DB5	Data Bus
13	DB6	Data Bus
14	DB7	Data Bus
15	LED_A	LED Power Supply + (5.0V)
16	LED_K	LED Power Supply - (0V)

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2.3 Timing Characteristics

DC Characteristics

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Characteristics	Symbol	Limit			Unit	Test Condition
		Min.	Typ.	Max.		
Operating Current	IDD	-	0.55	0.6	mA	External clock (Note)
Input High Voltage	V_{IH1}	2.2	-	VDD	V	Pins:(E, RS, R/W, DB7 - 0)
Input Low Voltage	V_{IL1}	-0.3	-	0.6	V	
Input High Voltage	V_{IH2}	VDD-1	-	VDD	V	Pin OSC1
Input Low Voltage	V_{IL2}	-0.2	-	1.0	V	Pin OSC1
Input High Current	I_{IH}	-2.0	-	2.0	µA	Pins: (RS, R/W, DB7 - 0)
Input Low Current	I_{IL}	-20.0	-50.0	-100.0	µA	VDD = 5.0V
Output High Voltage (TTL)	V_{OH1}	2.4	-	VDD	V	I_{OH} = 0.1mA Pins: DB7 - 0
Output Low Voltage (TTL)	V_{OL1}	-	-	0.4	V	I_{OL} = 0.1mA Pins: DB7 - 0
Output High Voltage (CMOS)	V_{OH2}	0.9VDD	-	VDD	V	I_{OH} = - 40.0µA, Pins: CL1, CL2, M, D
Output Low Voltage (CMOS)	V_{OL2}	-	-	0.1VDD	V	I_{OL} = 40.0µA. Pins: CL1, CL2, M, D
Driver ON Resistance (COM)	R_{COM}	-	-	20.0	KΩ	I_O = ±50.0µA, V_{LCD} = 4.0V Pins: COM16 - 1
Driver ON Resistance (SEG)	R_{SEG}	-	-	30.0	KΩ	I_O = ±50.0µA, V_{LCD} = 4.0V Pins: SEG40 - 1
LCD Voltage	V_{LCD}	3.0	-	11.0	V	VDD - V5, 1/4 bias or 1/5 bias

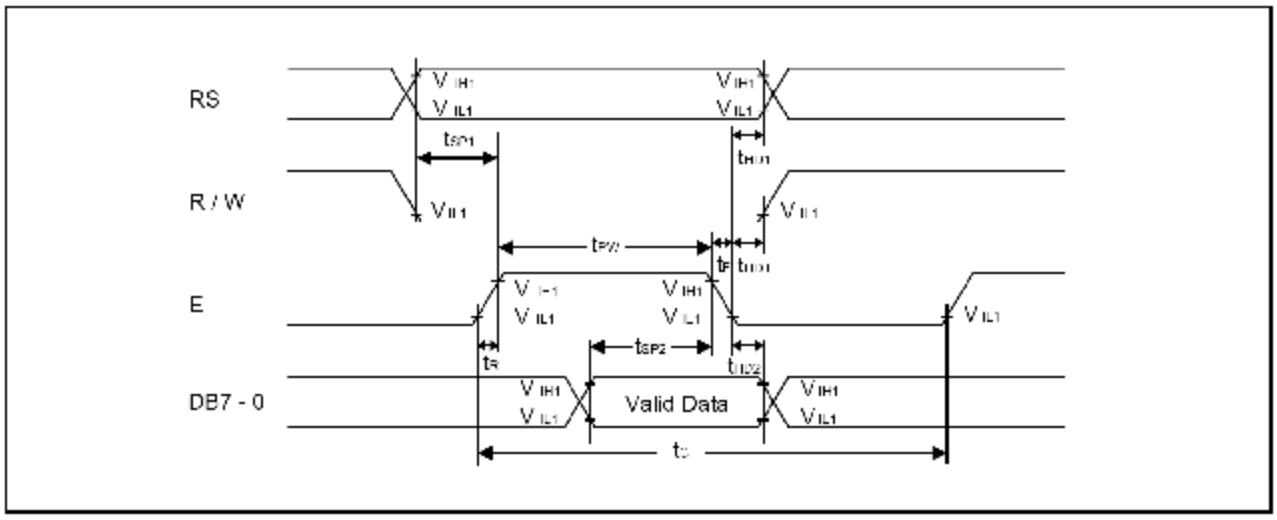
Note: F_{OSC} = 250.0KHz, VDD = 5.0V, pin E = "L", RS, R/W, DB7 - 0 are open, all outputs are no loads.

AC Characteristics

Characteristics	Symbol	Limit			Unit	Test Condition
		Min.	Typ.	Max.		
OSC Frequency	F_{OSC1}	190.0	270.0	350.0	KHz	VDD = 5.0V Rf = 91.0KΩ±2%

Timing Diagram

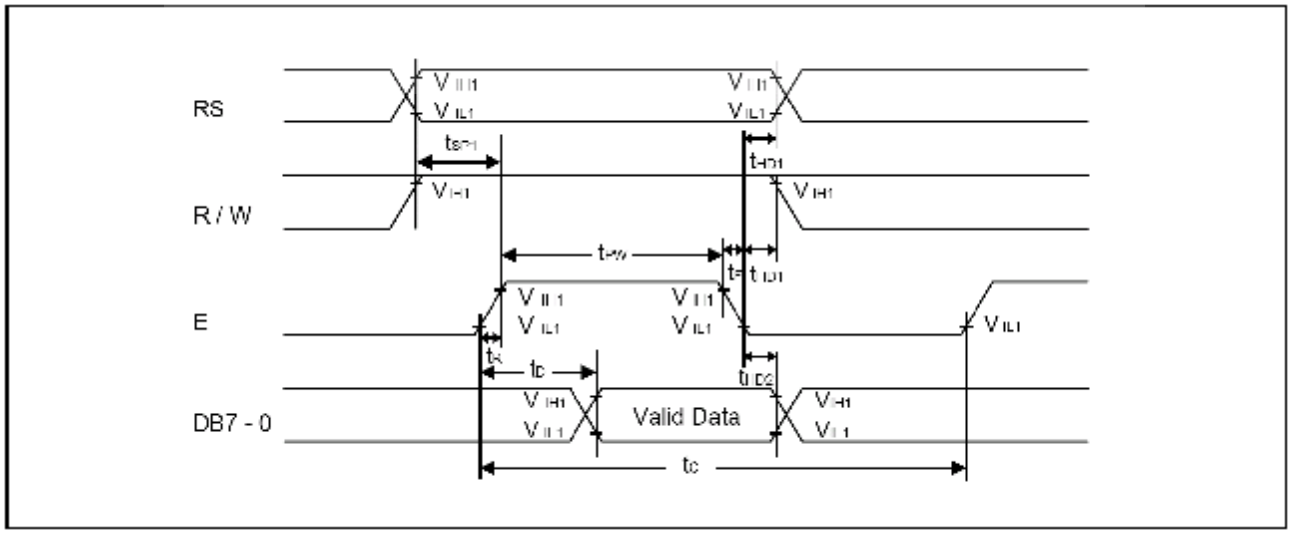
Writing mode



Characteristics	Symbol	Limit			Unit	Test Condition
		Min.	Typ.	Max.		
E Cycle Time	t_C	400.0	-	-	ns	Pin E
E Pulse Width	t_{PW}	150.0	-	-	ns	Pin E
E Rise/Fall Time	t_R, t_F	-	-	25.0	ns	Pin E
Address Setup Time	t_{SP1}	30.0	-	-	ns	Pins: RS, R/W, E
Address Hold Time	t_{HD1}	10.0	-	-	ns	Pins: RS, R/W, E
Data Setup Time	t_{SP2}	40.0	-	-	ns	Pins: DB7 - 0
Data Hold Time	t_{HD2}	10.0	-	-	ns	Pins: DB7 - 0

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Read mode



Characteristics	Symbol	Limit			Unit	Test Condition
		Min.	Typ.	Max.		
E Cycle Time	t_C	400.0	-	-	ns	Pin E
E Pulse Width	t_W	150.0	-	-	ns	Pin E
E Rise/Fall Time	t_R, t_F	-	-	25.0	ns	Pin E
Address Setup Time	t_{SP}	30.0	-	-	ns	Pins: RS, R/W,E
Address Hold Time	t_{HD1}	10.0	-	-	ns	Pins: RS, R/W,E
Data Output Delay Time	t_D	-	-	100.0	ns	Pins: DB7 - 0
Data hold time	t_{HD2}	20.0	-	-	ns	Pin DB7 - 0

2.4 Instruction Table

◆ Display Control Instruction

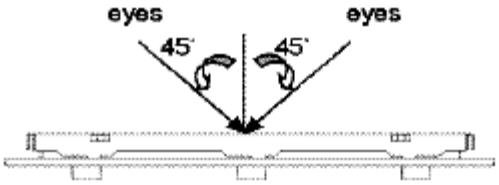
Instruction	Instruction Code										Description	Execution time (F_{osc} = 270KHz)
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM and set DDRAM address to "00H" from AC	1.52ms
Return Home	0	0	0	0	0	0	0	0	1	-	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.52ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Assign cursor moving direction and enable the shift of entire display	38μs
Display ON/ OFF Control	0	0	0	0	0	0	1	D	C	B	Set display(D), cursor(C), and blinking of cursor(B) on/off control bit.	38μs
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	-	-	Set cursor moving and display shift control bit, and the direction without changing of DDRAM data.	38μs
Function Set	0	0	0	0	1	DL	N	F	-	-	Set interface data length (DL: 8-bit/4-bit), numbers of display line (N: 2-line/1-line) and, display font type (F: 5x10 dots/5x8 dots)	38μs
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	38μs
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in counter	38μs
Read Busy Flag and Address Counter	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	38μs
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	38μs

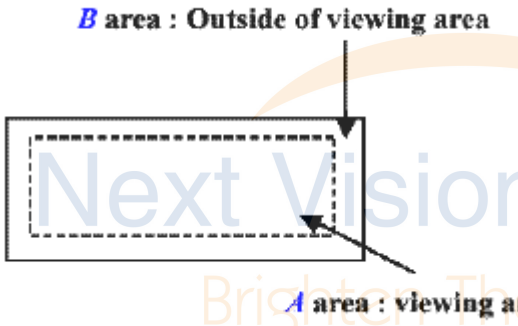
*"-": don't care

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2.6 Inspection Specification

◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ .
◆Equipment : Gauge、MIL-STD、Powertip Tester、Sample
◆Defect Level : Major Defect AQL 0.4; Minor Defect AQL 1.5 .
◆OUT Going Defect Level : Sampling .
◆Manner of appearance test :
(1). The test be under 40W×2 fluorescent light ' and distance of view must be at 30 cm.
(2). The test direction is base on about around 45° of vertical line. (Fig. 1)
(3). Definition of area . (Fig. 2)



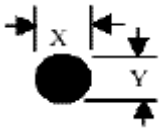


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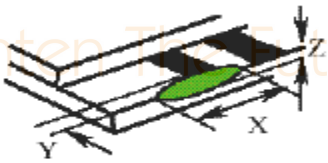
◆ Specification:

NO	Item	Criterion	level
01	Product condition	1.1 The part number is inconsistent with work order of Production.	Major
		1.2 Mixed production types.	Major
		1.3 Assembled in inverse direction.	Major
02	Quantity	2.1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major
04	Electrical Testing	4.1 Missing line character、dot and icon.	Major
		4.2 No function or no display.	Major
		4.3 Output data is error.	Major
		4.4 LCD viewing angle defect.	Major
		4.5 Current consumption exceeds product specifications.	Major
05	Black or white dot、scratch、contamination Round type	5.1 Round type: 5.1.1 display only : White and black spots on display ≦ 0.25mm, no more than Four white or black spots present. Densely spaced : NO more than two spots or lines within 3mm	Minor

◆Specification :

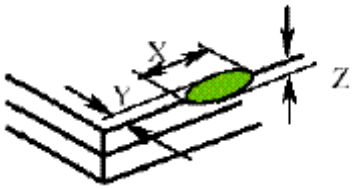
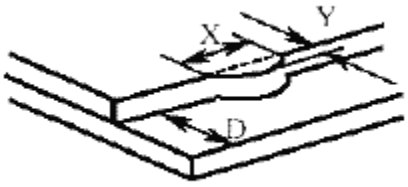
NO	Item	Criterion	level
05	Black or white dot、scratch、contamination Round type  Φ=(x+y)/2  	5.1.2 Nom-display : Dimension (diameter : Φ) Acceptance(Q'ty) Φ≦0.10mm Accept no dense 0.10mm＜Φ≦0.20mm 3 0.20mm＜Φ≦0.25mm 2 Total 4 5.1.3 Line type: Dimension (diameter : Φ) Acceptance (Q'ty) Length width A area B area --- w≦0.03mm Accept no dense Don't count L≦3.0mm 0.03mm＜Φ≦0.05mm 4 Don't count L≦2.5mm 0.05mm＜Φ≦0.075mm Don't count --- w＞0.075mm As round type	Minor

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06	Polarizer Bubble	Dimension (diameter : Φ) Acceptance(Q'ty) A area B area Φ≦0.20mm Accept no dense Don't count 0.20mm＜Φ≦0.50mm 3 Don't count 0.50mm＜Φ≦1.00mm 2 Don't count Φ＞1.00mm 0 Don't count Total quantity 4 Don't count	Minor
07	The crack of glass	● Glass Crack: 7.1 Crack on the circuit of electrode terminal :  X Y Z Front X≦1/5 a Y≦ 1/2 D Z≦ t Back Neglect	Minor

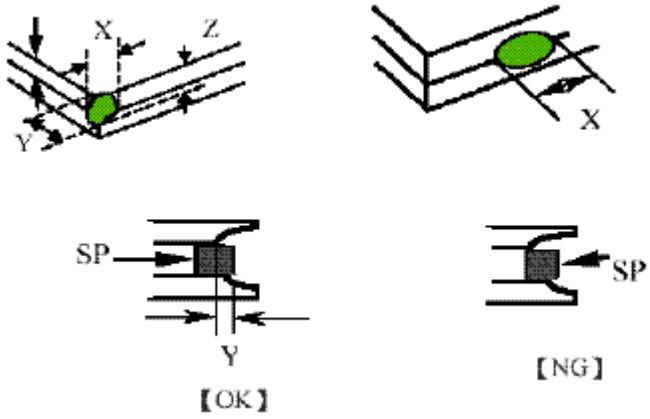
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◆Specification :

NO	Item	Criterion	Level
07	The crack of glass X: The length of Crack Y: The width of crack Z: The thickness of crack D: terminal length T: The thickness of glass A : The length of glass	● Glass Crack: 7.2 General glass crack and corner edge: 7.2.1  X Neglect Y Out A area Z Neglect 7.2.2  X Neglect Y Out A area Z Neglect	Minor
		7.3 Glass remain:  X Neglect Y ≦ 1/3 d	Minor

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◆Specification :

NO	Item	Criterion	Level
07	The crack of glass X: The length of Crack Y: The width of crack Z: The thickness of crack D: terminal length T: The thickness of glass A : The length of glass	7.4 Corner crack and medial crack:  X Y Z ≦1/5a Crack can't enter viewing area ≦1/2t ≦1/5a Crack can't exceed the half of width of SP width of SP 1/2t<Z≦2t	Minor
08	Backlight elements	8.1 Backlight can't work normally.	Major
		8.2 Backlight doesn't light or color is wrong.	Major
		8.3 Illumination source flickers when lit.	Major
09	General appearance	9.1 pin type must match type in specification sheet	Major
		9.2 No short circuits in components on PCB or FPC	Major
		9.3Product packaging must the same as specified on packaging specification sheet.	Major
		9.4 The folding and peeled off in polarizer are not acceptable	Major
		9.5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≦1.5mm	Major

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